

Low-Profile 140-W Full-Bridge Reference Design



Description

This power supply is a 140-W, full-bridge reference design for applications requiring high density and low component heights due to the planar transformer. The design is based on a hard-switched full bridge topology, using Schottky diodes on the secondary side, driven by the LM5045. A planar transformer is used to minimize the footprint and height. The printed circuit board (PCB) has six layers and the components are assembled top and bottom. The unit is designed for continuous operation at a rated load at $T_A < 40^\circ\text{C}$. A minimum airflow of 200 linear feet per minute (LFM) is recommended for higher ambient temperature.

Features

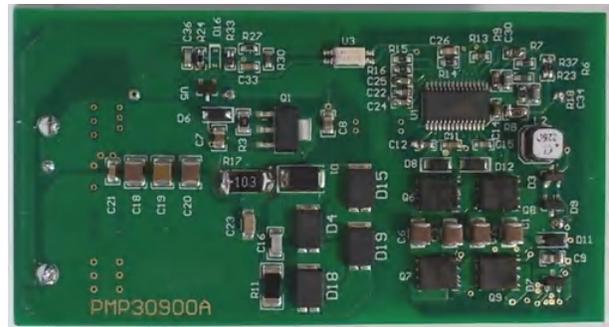
- Low-profile, 140-W, full-bridge power converter
- 19- V_{DC} to 30- V_{DC} input, 56 V_{DC} 2.5-A output
- 94.4% peak efficiency at 18- V_{DC} input and 56-W load
- Compact board dimensions: 47 mm \times 84.2 mm, 11.34-mm height

Applications

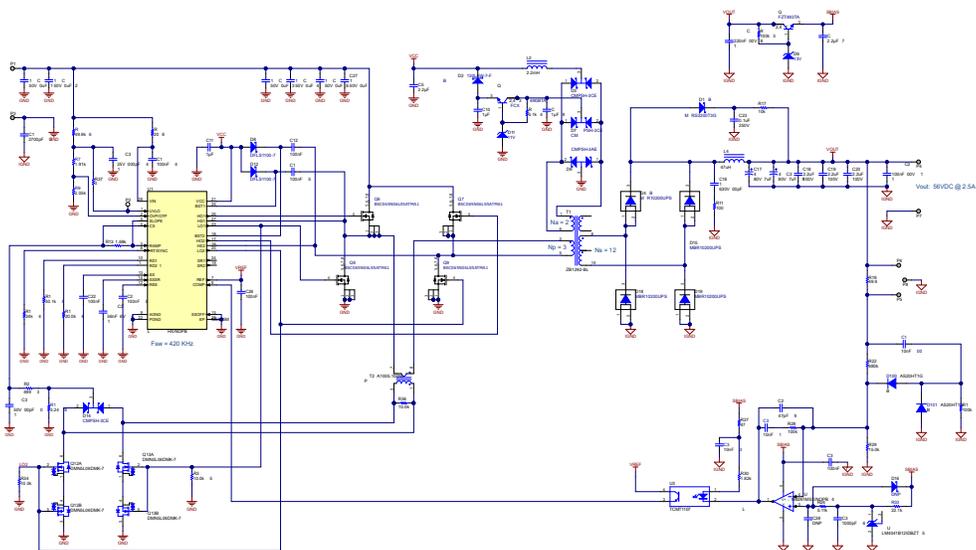
- [Machine vision lighting](#)



Top Photo



Bottom Photo



Schematic

1 Test Prerequisites

1.1 Voltage and Current Requirements

Table 1-1. Voltage and Current Requirements

Parameter	Specifications
Input Voltage	19 V _{DC} to 30 V _{DC}
Output Voltage	56 V _{DC}
Output Current	2.5 A

1.2 Required Equipment

- 15 V_{DC} to 32 V_{DC}, minimum output current 10 A, constant voltage source (VS1)
- Electronic load, in constant current regulation, range 0 to 3 A (EL1)
- Electric fan 200 LFM
- Oscilloscope (minimum 200-MHz bandwidth)
- Current probe (minimum 100-kHz bandwidth)
- Optional: infrared camera

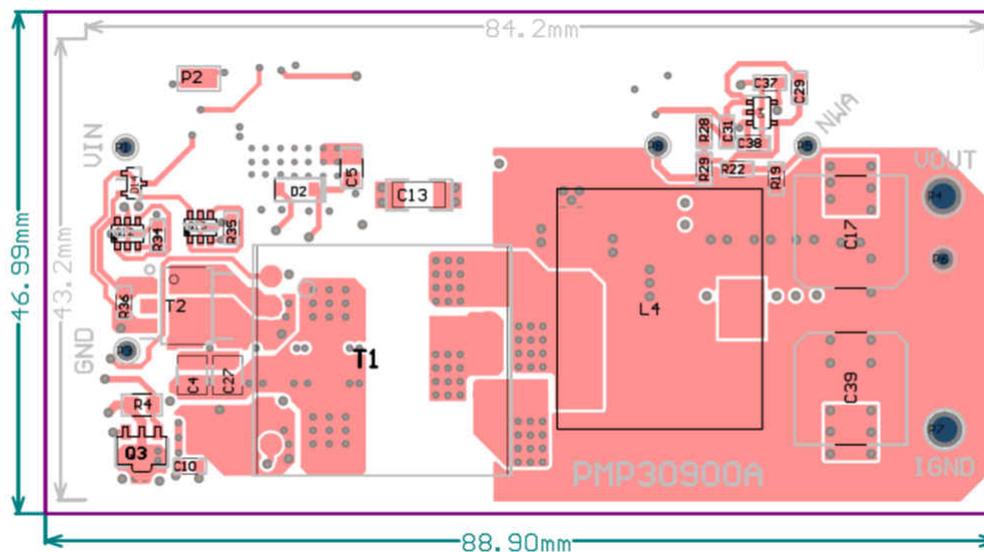
1.3 Considerations

The board is built on PCB PMP30900RevA.

1.4 Dimensions

The board dimensions are 88.9 mm × 46.99 mm, with the height of 11.34 mm (Transformer T1), while the net PCB area dimensions are 84.22 mm x 43.2 mm.

The copper thickness of the six layer board is 70 μm on the outer layers and 35 μm on the inner layers (70-30-30-30-70).



1.5 Test Setup

1. Connect the source VS1 to P1 (positive) and P3 (negative).
2. Add an electrolytic capacitor (> 1 mF, ESR < 30 mΩ) close to input terminals in case long cables from VS1 are used
3. Connect the load EL1 to P4 and P7 (P7 is the secondary side ground)
4. Attach a current probe in series to EL1 to measure the output current during load transients
5. Turn on VS1
6. Increase the load current (maximum current 2.5 A)

2 Testing and Results

2.1 Efficiency Graphs

Figure 2-1 shows the efficiency graph of the power supply versus output current. The input voltage has been set to 18 V_{DC}, 24 V_{DC}, and 30 V_{DC}.

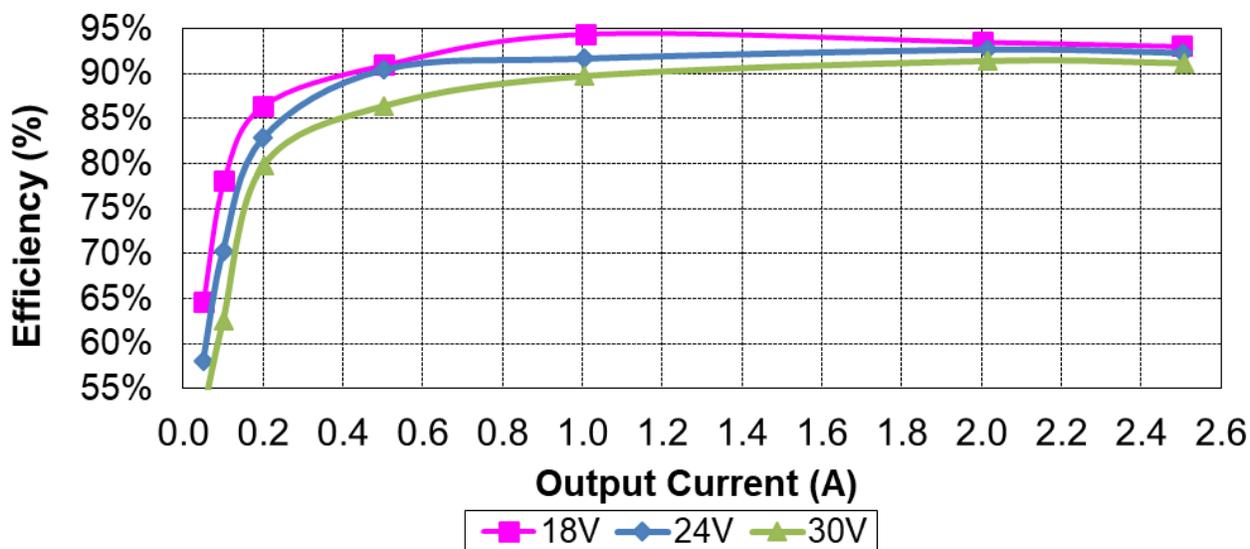


Figure 2-1. Efficiency Graph

2.2 Efficiency Data

Efficiency data is shown in the following tables.

Table 2-1. Efficiency Data for 18-V Input Voltage

V _{IN} (V)	I _{IN} (A)	P _{IN} (W)	V _{OUT} (V)	I _{OUT} (A)	P _{OUT} (W)	Efficiency (%)
18.010	0.022	0.398	56.300	0.000	0	0.0%
18.010	0.242	4.357	56.300	0.050	2.815	64.61%
18.000	0.406	7.306	56.300	0.101	5.703	78.06%
18.050	0.723	13.050	56.290	0.200	11.281	86.44%
18.040	1.724	31.101	56.290	0.503	28.291	90.97%
18.018	3.327	59.946	56.210	1.007	56.603	94.42%
18.023	6.681	120.412	56.260	2.002	112.63	93.54%
18.030	8.384	151.164	56.250	2.501	140.68	93.07%

Table 2-2. Efficiency Data for 24-V Input Voltage

V _{IN} (V)	I _{IN} (A)	P _{IN} (W)	V _{OUT} (V)	I _{OUT} (A)	P _{OUT} (W)	Efficiency (%)
24.070	0.016	0.378	56.300	0.000	0	0.0%
24.040	0.205	4.938	56.300	0.051	2.866	58.04%
24.000	0.336	8.059	56.300	0.101	5.664	70.28%
24.000	0.567	13.603	56.290	0.200	11.264	82.80%
24.000	1.305	31.320	56.280	0.503	28.326	90.44%
24.080	2.559	61.621	56.260	1.004	56.491	91.67%
24.070	5.084	122.372	56.250	2.016	113.40	92.67%
24.070	6.343	152.676	56.240	2.506	140.94	92.31%

Table 2-3. Efficiency Data for 30-V Input Voltage

V_{IN} (V)	I_{IN} (A)	P_{IN} (W)	V_{OUT} (V)	I_{OUT} (A)	P_{OUT} (W)	Efficiency (%)
30.03	0.0170	0.511	56.25	0	0	0.0%
30.02	0.1817	5.455	56.26	0.0507	2.852	52.29%
30.02	0.3012	9.042	56.27	0.1004	5.650	62.48%
30.01	0.4733	14.204	56.27	0.2014	11.333	79.79%
30.05	1.0913	32.794	56.27	0.5035	28.332	86.39%
30.04	2.096	62.964	56.26	1.004	56.479	89.70%
30.01	4.130	123.941	56.24	2.014	113.27	91.39%
30.03	5.153	154.745	56.24	2.508	141.05	91.15%

2.3 Thermal Images

The graphs in [Figure 2-2](#) and [Figure 2-3](#) show the thermal pictures of the converter supplied at 24 V_{DC} at full load. [Table 2-4](#) and [Table 2-5](#) represent the corresponding values of the main image markers.

Thermal shots were taken after the board was running for 30 minutes at an ambient temperature of 25°C.

The board runs at full load with a fan, placed on the right side of the prototype.

2.3.1 Top Side

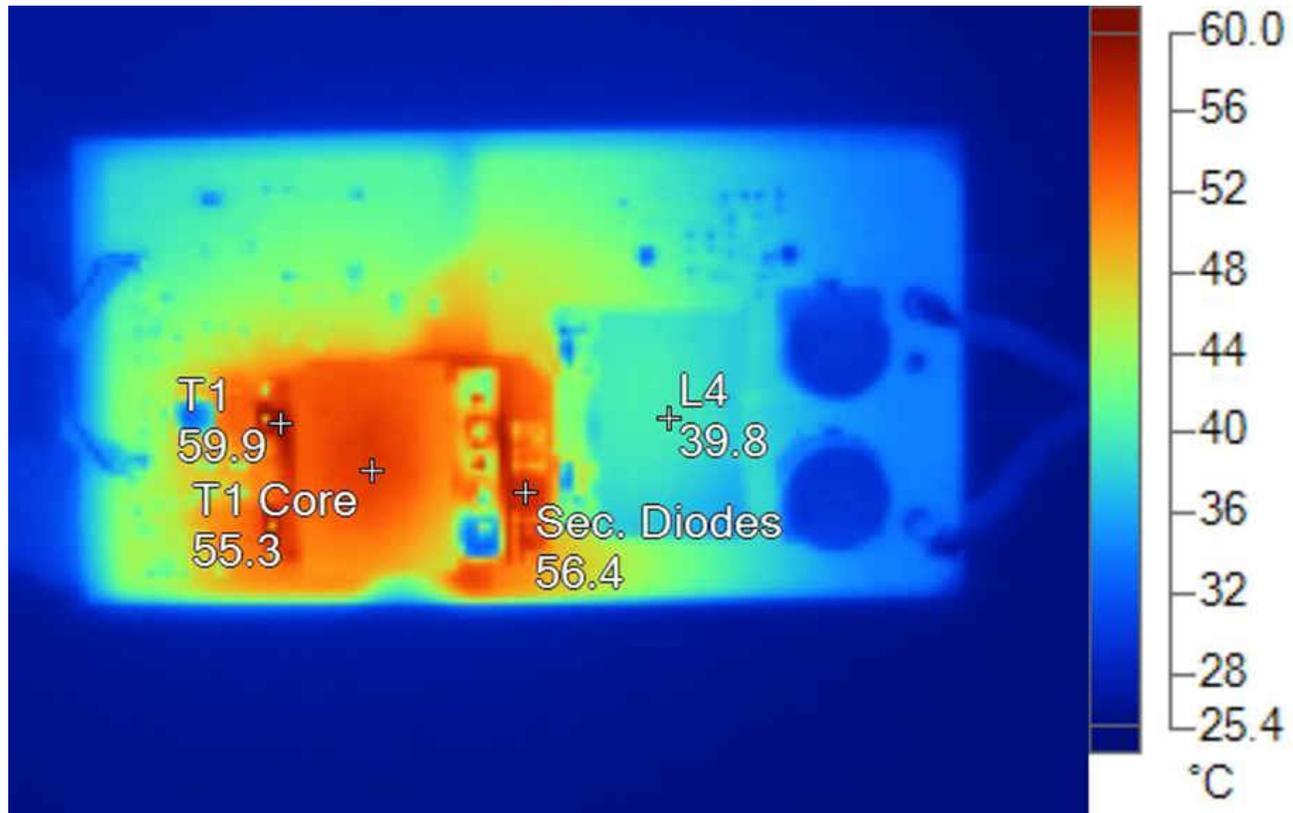


Figure 2-2. Thermal Image: Top View

Table 2-4. Main Image Markers

Name	Temperature	Emissivity	Background
T1	59.9°C	0.96	25.5°C
T1 Core	55.3°C	0.96	25.5°C
Diodes (secondary side)	56.4°C	0.96	25.5°C
L4	39.8°C	0.96	25.5°C

2.3.2 Bottom Side

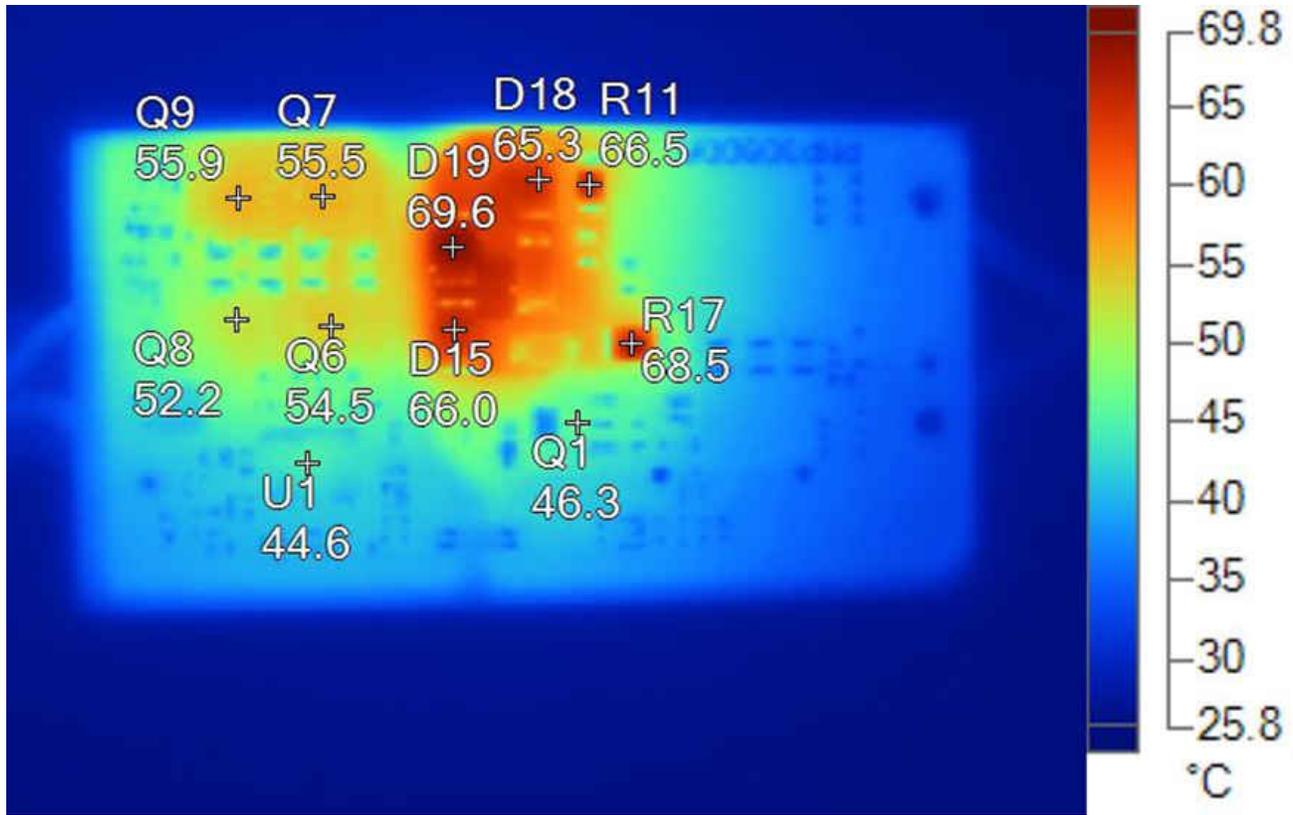


Figure 2-3. Thermal Image: Bottom Side

Table 2-5. Main Image Markers

Name	Temperature	Emissivity	Background
Q9	55.9°C	0.96	25.5°C
Q7	55.5°C	0.96	25.5°C
D19	69.6°C	0.96	25.5°C
D18	65.3°C	0.96	25.5°C
R11	66.5°C	0.96	25.5°C
R17	68.5°C	0.96	25.5°C
Q1	46.3°C	0.96	25.5°C
D15	66.0°C	0.96	25.5°C
U1	44.6°C	0.96	25.5°C
Q8	52.2°C	0.96	25.5°C
Q6	54.5°C	0.96	25.5°C

2.4 Bode Plots

The graph in [Figure 2-4](#) shows the bode plot of the converter, when supplied at 24 V_{DC} and loaded at 2.5 A. Here are the results, in terms of crossover frequency, phase margin, and gain margin:

Parameter	Full Load
Crossover frequency	2.859 kHz
Phase margin	80.84°
Gain margin	29.25 dB

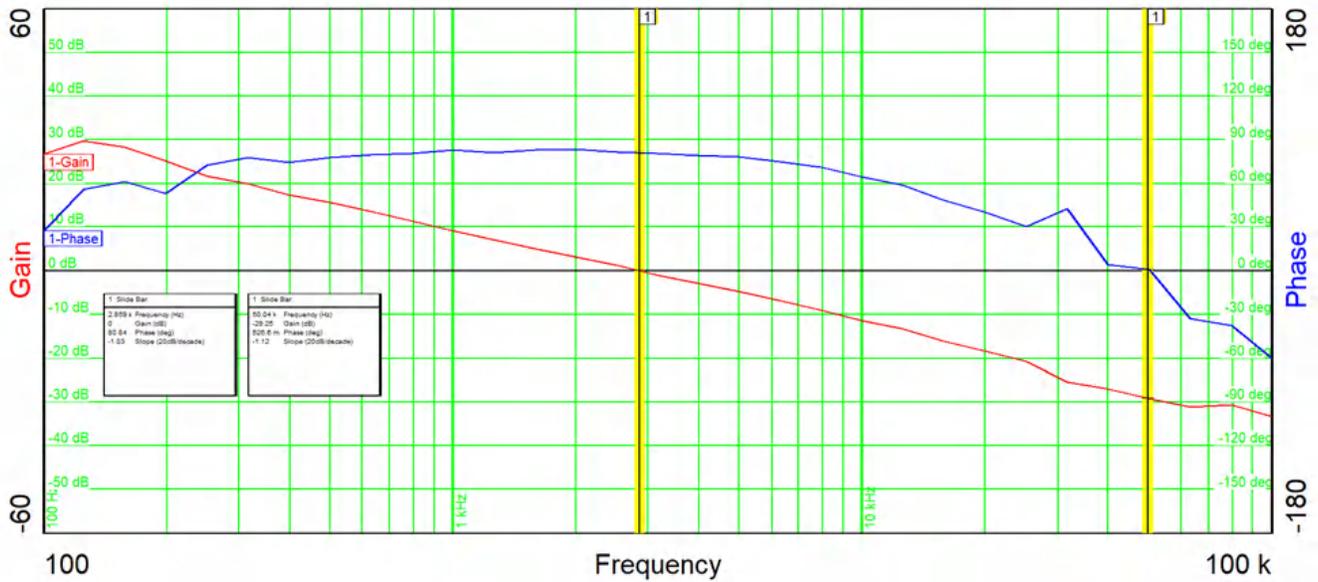


Figure 2-4. Bode Plot

3 Waveforms

3.1 Switching

The switching waveforms were measured by supplying the converter at 30 V_{DC} and full load.

3.1.1 Secondary Side

The waveform in [Figure 3-1](#) represents the switching behavior measured on diode D4-cathode to IGND.

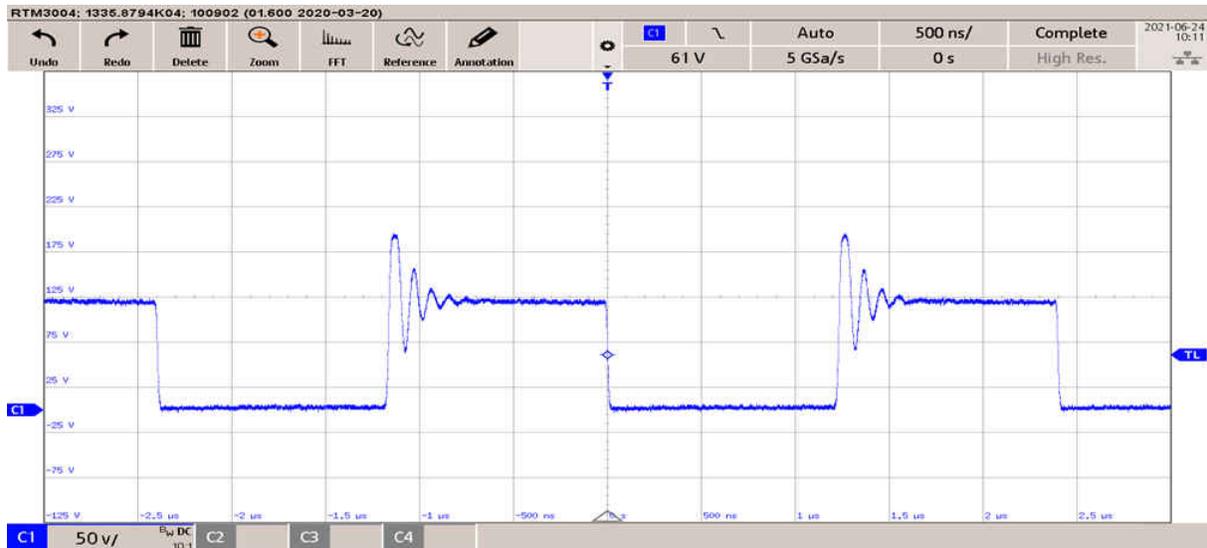


Figure 3-1. Switch-Node Secondary Side (50 V / div, 500 ns / div, no bandwidth limit (BWL))

3.1.2 Primary Side

3.1.2.1 Transistor Q8 Drain-Source

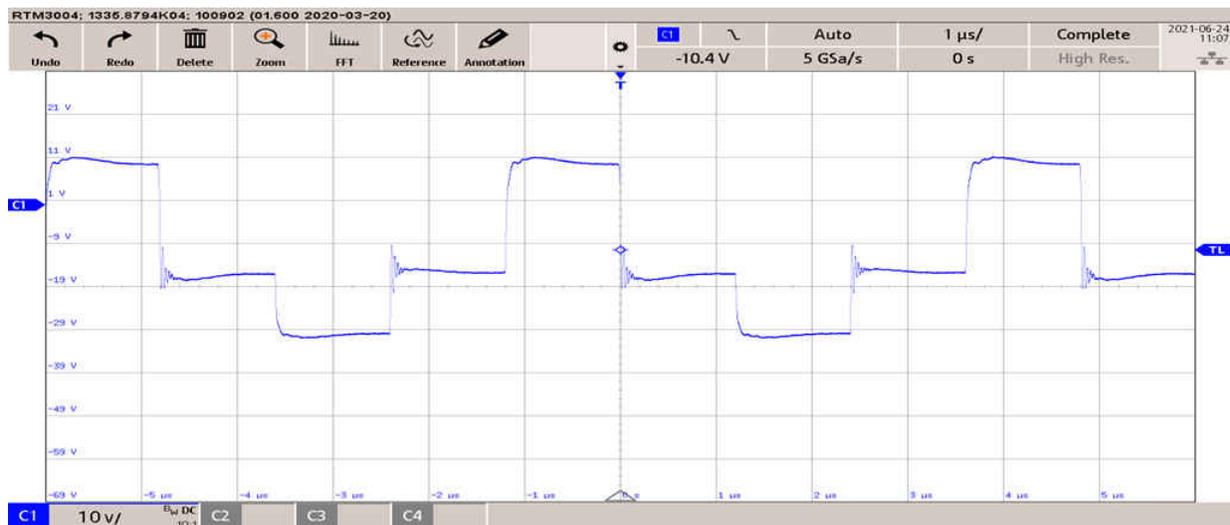


Figure 3-2. Switch-Node Q8 Drain to Source (10 V / div, 1 μs / div, no BWL)

3.1.2.2 HS2-Pin of U1

3.1.2.2.1 Undershoot

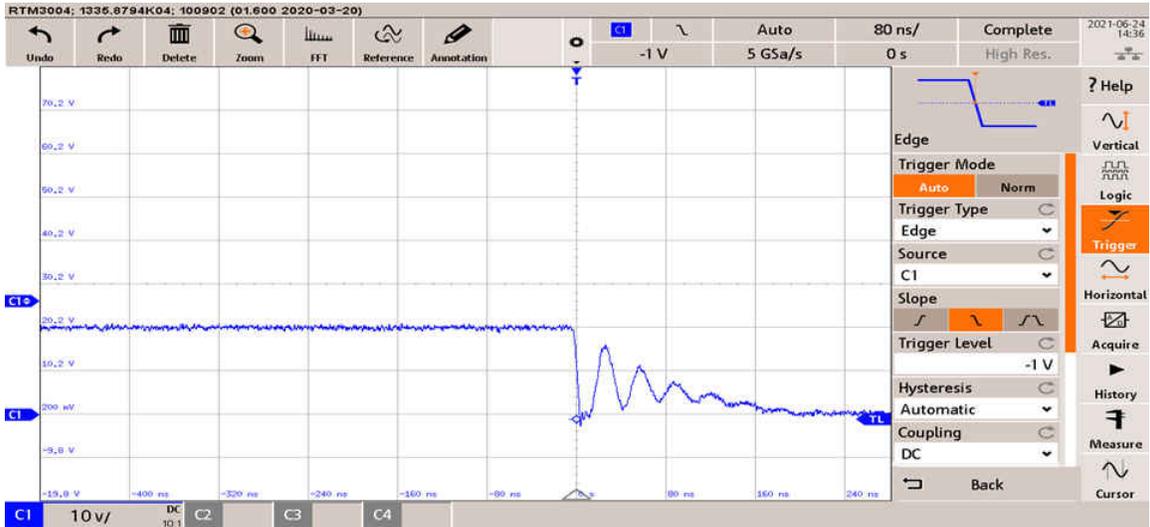


Figure 3-3. Voltage on HS2 pin (16) of U1 (10 V / div, 80 ns / div, no BWL), Detail of Undershoot

3.1.2.2.2 Overshoot

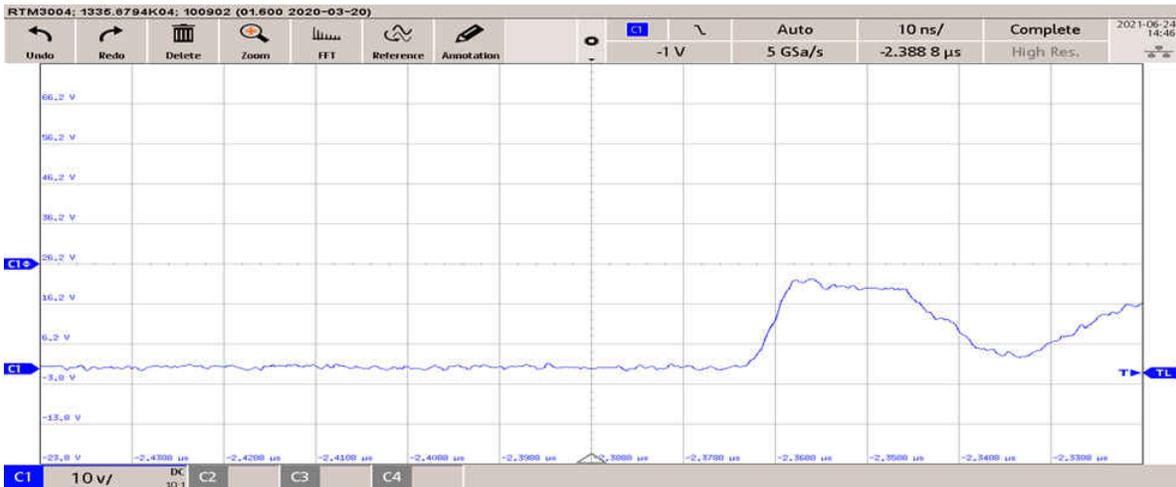


Figure 3-4. Voltage on HS2 pin 16 of U1 (10 V / div, 10 ns / div, no BWL), Detail of Overshoot

3.2 Output Voltage Ripple

The output voltage ripple was measured by supplying the converter at 24 V_{DC} and full load; the bandwidth limit of the scope was set to 20 MHz.

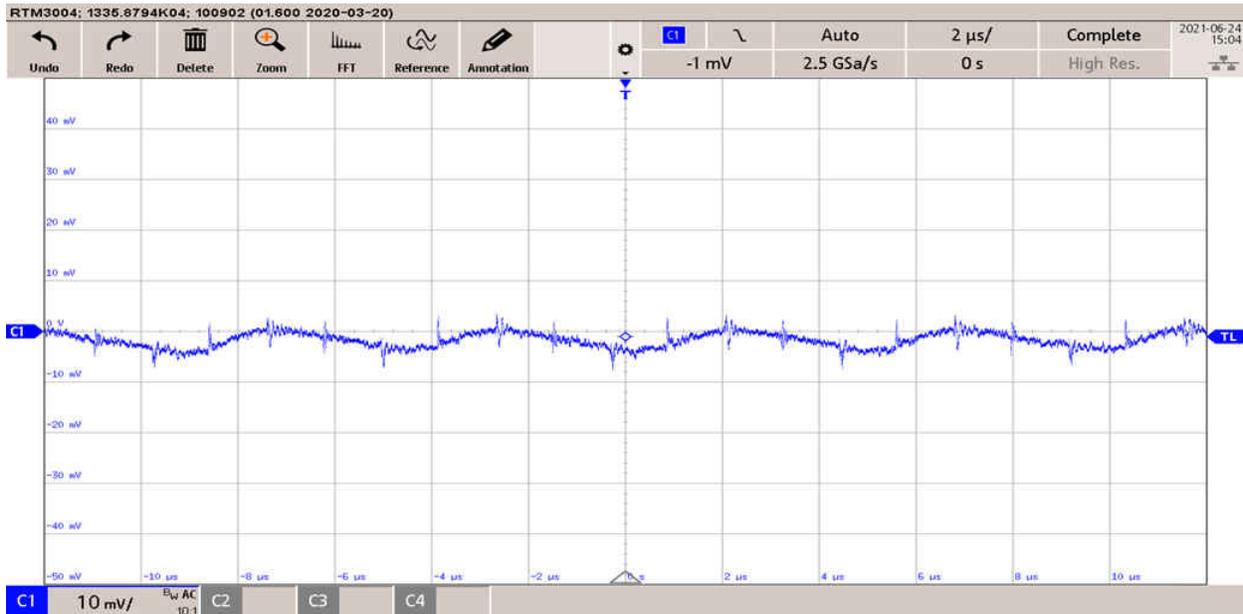


Figure 3-5. Output Voltage (10 mV/ div, 2 µs /div), AC Coupling, 20-MHz BWL)

3.3 Load Transients

The output voltage variation, during load transients, was measured by supplying the converter at 24 V_{DC} and by switching the load current between 1.25 A and 2 A. For all waveforms, the bandwidth limit of the oscilloscope was set to 20 MHz

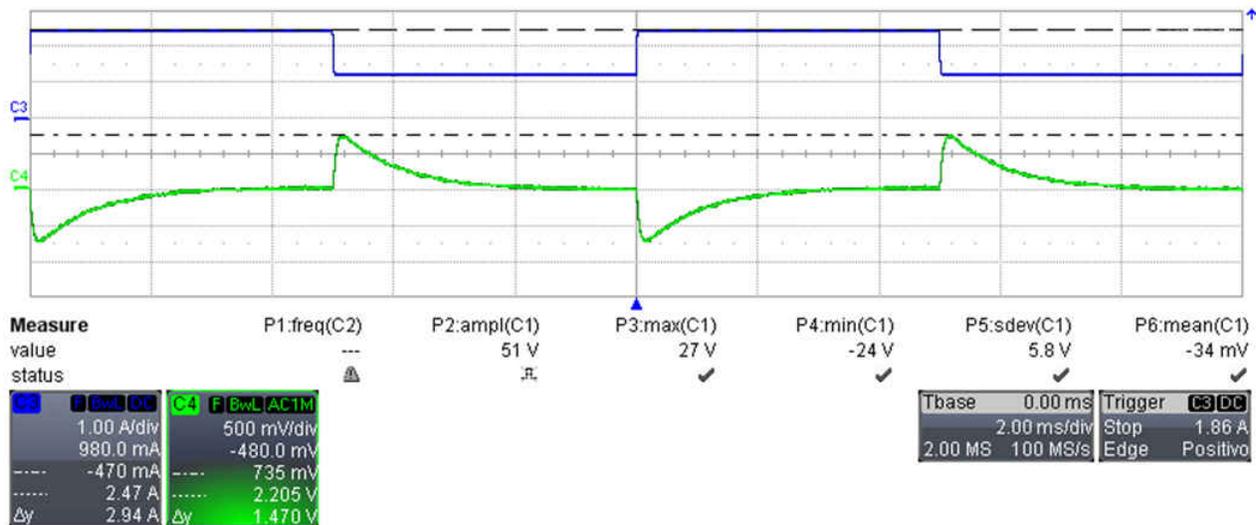


Figure 3-6. Load Transients 1.25 A to 2 A

- Channel C4: Output voltage (500 mV / div, 2 ms / div, AC coupling)
- Channel C3: Output current (1 A / div, DC coupling)

3.4 Start-Up Sequence

The screen shots in [Figure 3-7](#) and [Figure 3-8](#) show the output voltage behavior during start-up, at $V_{IN} = 24 V_{DC}$.

3.4.1 Full Load

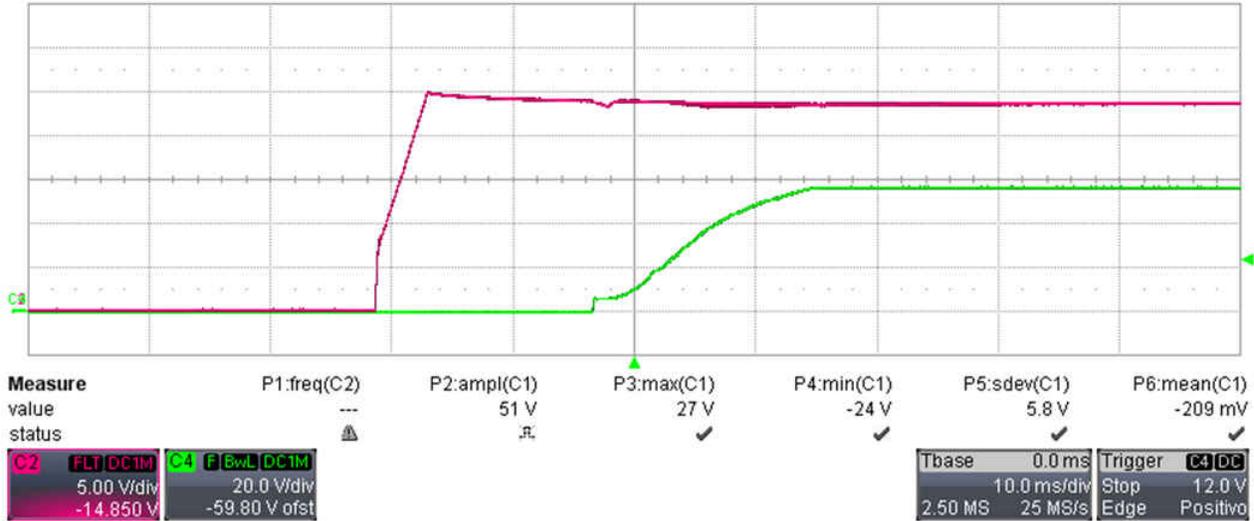


Figure 3-7. Start-Up With Full Load

- Channel C2: Input voltage (5 V /div, 10 ms / div, DC coupling, 20-MHz BWL)
- Channel C4: Output voltage (20 V/div, DC coupling, 20-MHz BWL)

3.4.2 Zero Load

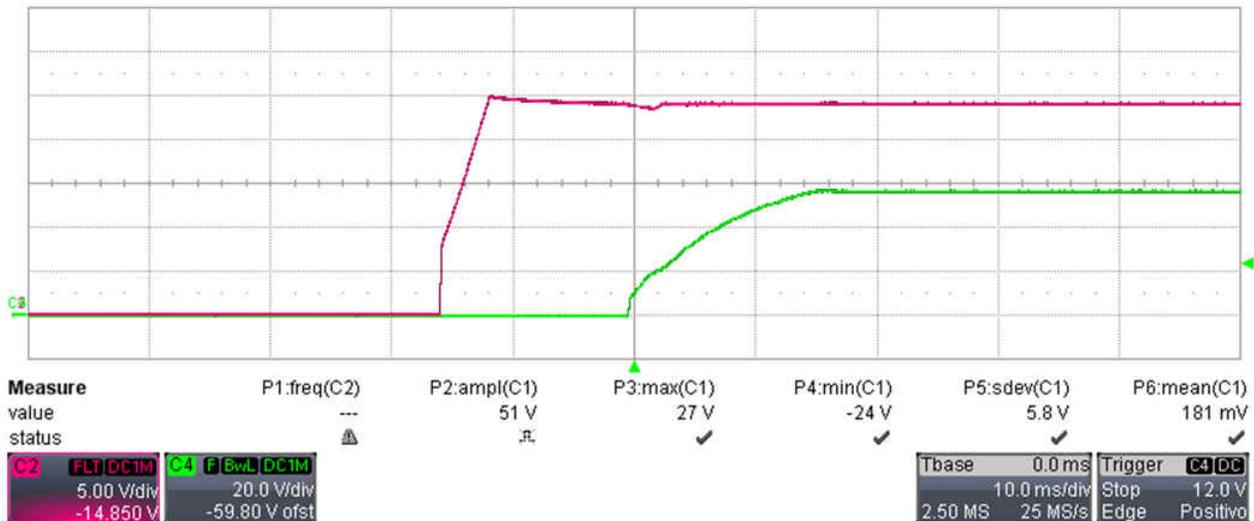


Figure 3-8. Start-Up With Zero Load

- Channel C2: Input voltage (5 V / div, 10 ms / div, DC coupling, 20-MHz BWL)
- Channel C4: Output voltage (20 V / div, DC coupling, 20-MHz BWL)

3.4.3 Overload

The following screen shots (Figure 3-9 and Figure 3-10) show the output voltage during start-up and overload protection, when the converter was loaded at 3.5 A.

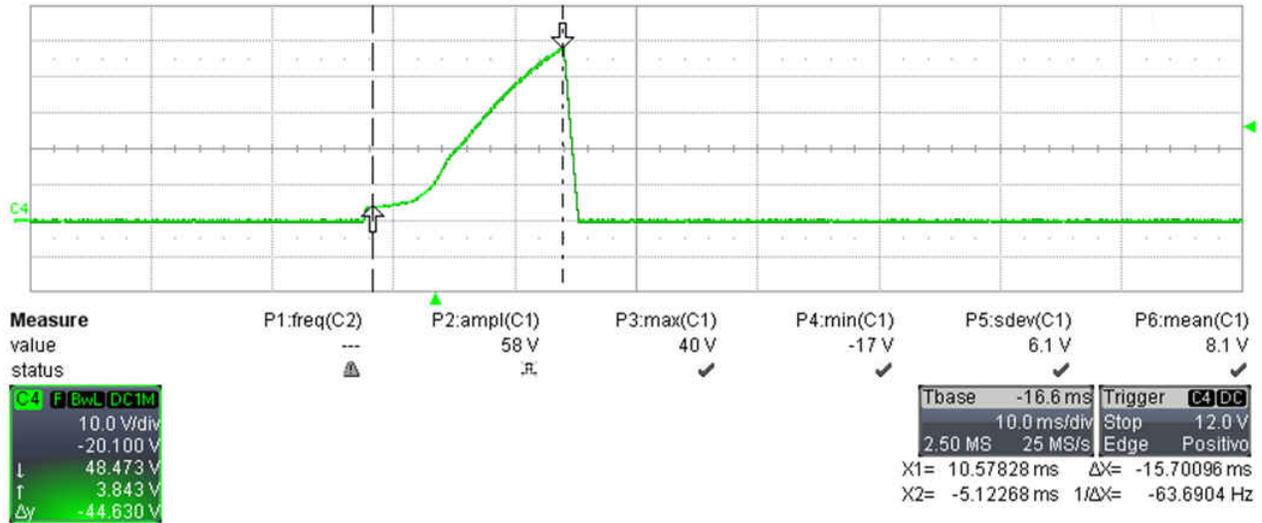


Figure 3-9. Start-Up With Overload Condition (3.5 A), Time Base: 10 ms / div

- Channel C4: Output voltage (10 V /div, 10 ms / div, DC coupling, 20-MHz BWL)

The same condition as in Figure 3-9 with different time base results in Figure 3-10.

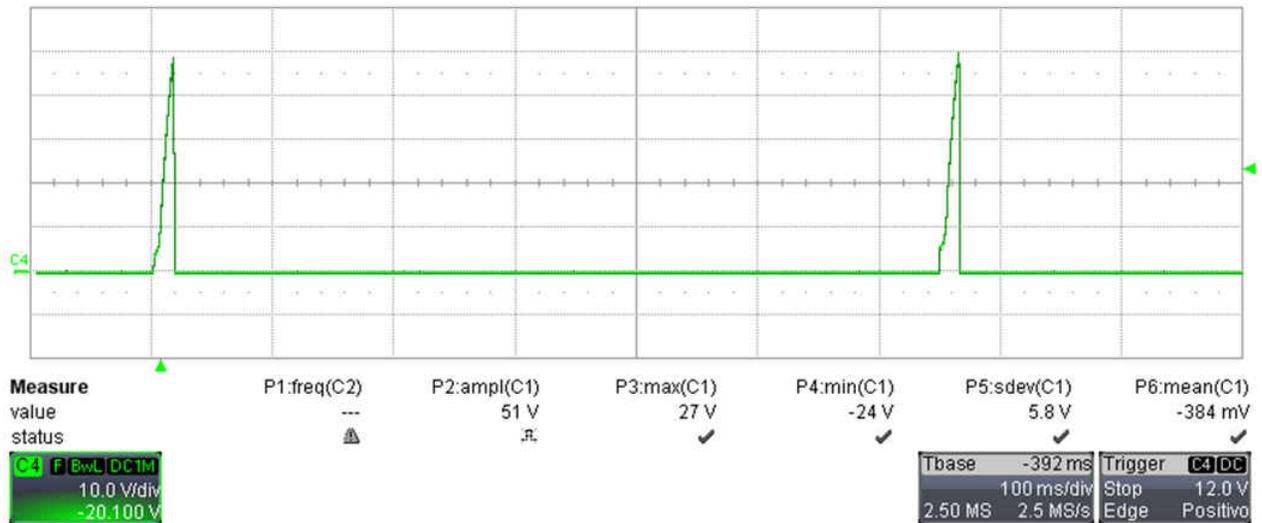


Figure 3-10. Start-Up With Overload Condition (3.5 A), Time Base: 100 ms / div

- Channel C4: Output voltage (10 V / div, 100 ms / div, DC coupling, 20-MHz BWL)

3.5 Shutdown Sequence

The output voltage has been measured by switching off the DC voltage source while the load was set to 2.5 A and V_{IN} to 24 V_{DC}

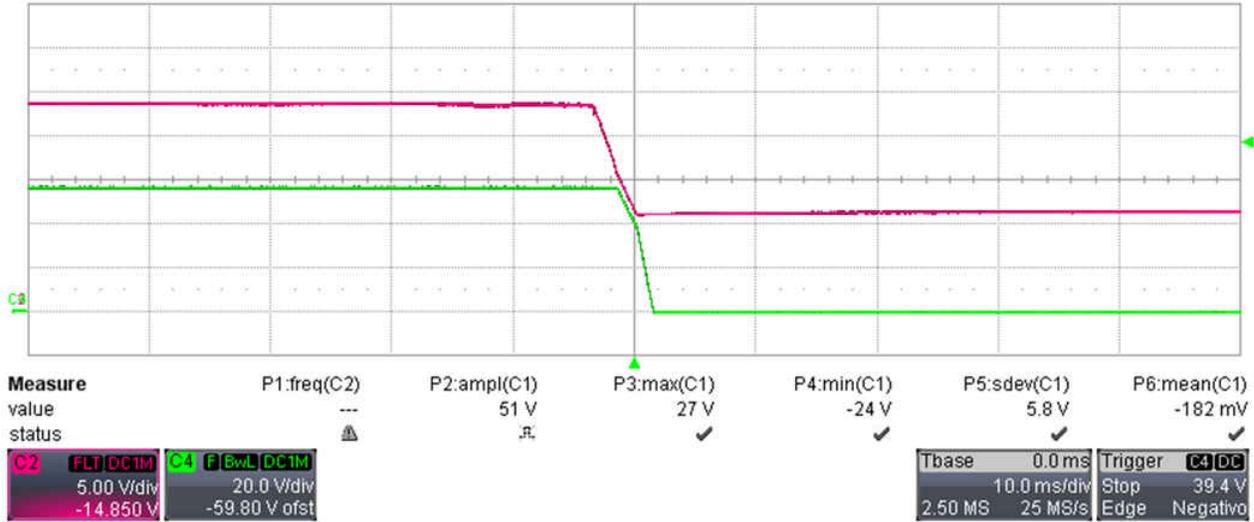


Figure 3-11. Shutdown Sequence

- Channel C2: Input voltage (5 V/ div, 10 ms /div, DC coupling, 20-MHz BWL)
- Channel C4: Output voltage (20 V / div, DC coupling, 20-MHz BWL)

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